



LEXANT™ RESIN LS2

REGION EUROPE

DESCRIPTION

LEXANT™ LS2 resin is a 11 MFR polycarbonate, MVR of 12. UV stabilized. UL94 HB rated. UL746C f1 rated. Medium viscosity. For Automotive lens applications. AMECA listed.

TYPICAL PROPERTY VALUES

Revision 20201125

PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
MECHANICAL			
Taber Abrasion, CS-17, 1 kg	10	mg / 1000cy	SABIC method
Tensile Stress, yield, 50 mm/min	63	MPa	ISO 527
Tensile Stress, break, 50 mm/min	70	MPa	ISO 527
Tensile Strain, yield, 50 mm/min	6	%	ISO 527
Tensile Strain, break, 50 mm/min	120	%	ISO 527
Tensile Modulus, 1 mm/min	2350	MPa	ISO 527
Flexural Stress, yield, 2 mm/min	90	MPa	ISO 178
Flexural Modulus, 2 mm/min	2300	MPa	ISO 178
Ball Indentation Hardness, H358/30	95	MPa	ISO 2039-1
IMPACT			
Izod Impact, unnotched 80°10°3 +23°C	NB	kJ/m²	ISO 180/1U
Izod Impact, unnotched 80°10°3 -30°C	NB	kJ/m²	ISO 180/1U
Izod Impact, notched 80°10°3 +23°C	70	kJ/m²	ISO 180/1A
Izod Impact, notched 80°10°3 -30°C	12	kJ/m²	ISO 180/1A
Charpy 23°C, V-notch Edgew 80°10°3 sp=62mm	73	kJ/m²	ISO 179/1eA
Charpy -30°C, V-notch Edgew 80°10°3 sp=62mm	14	kJ/m²	ISO 179/1eA
Charpy 23°C, Unnotch Edgew 80°10°3 sp=62mm	NB	kJ/m²	ISO 179/1eU
Charpy -30°C, Unnotch Edgew 80°10°3 sp=62mm	NB	kJ/m²	ISO 179/1eU
THERMAL			
Thermal Conductivity	0.2	W/m.°C	ISO 8302
CTE, 23°C to 80°C, flow	7.E-05	1/°C	ISO 11359-2
Ball Pressure Test, 125°C +/- 2°C	PASSES	-	IEC 60695-10-2
Vicat Softening Temp. Rate B/50	141	°C	ISO 306
Vicat Softening Temp. Rate B/120	142	°C	ISO 306
HDT/Be, 0.45MPa Edgew 120°10°4 sp=100mm	136	°C	ISO 75/Be
HDT/Ae, 1.8 MPa Edgew 120°10°4 sp=100mm	125	°C	ISO 75/Ae
Relative Temp Index, Elec	130	°C	UL 746B
Relative Temp Index, Mech w/impact	130	°C	UL 746B
Relative Temp Index, Mech w/o impact	130	°C	UL 746B
PHYSICAL			
Mold Shrinkage on Tensile Bar, flow	0.5 – 0.7	%	SABIC method
Density	1.2	g / cm³	ISO 1183
Water Absorption, (23°C/saturated)	0.35	%	ISO 62-1
Moisture Absorption (23°C / 50% RH)	0.15	%	ISO 62



PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
Melt Volume Rate, MVR at 300°C/1.2 kg	12	cm³/10 min	ISO 1133
OPTICAL			
Light Transmission, 2.54 mm	88 – 90	%	ASTM D1003
Haze, 2.54 mm	<0.8	%	ASTM D1003
Refractive Index	1.586	-	ISO 489
ELECTRICAL			
Volume Resistivity	>1.E+15	Ω.cm	IEC 60093
Surface Resistivity, ROA	>1.E+15	Ω	IEC 60093
Dielectric Strength, shorttime, 1.0mm	15	kV/mm	IEC 60243-1
Dielectric Strength, in oil, 3.2 mm	17	kV/mm	IEC 60243-1
Relative Permittivity, 1 MHz	2.7	-	IEC 60250
Dissipation Factor, 50/60 Hz	0.001	-	IEC 60250
Dissipation Factor, 1 MHz	0.01	-	IEC 60250
Relative Permittivity, 50/60 Hz	2.7	-	IEC 60250
FLAME CHARACTERISTICS			
UL Yellow Card Link	E45329-236637	-	-
UL Recognized, 94HB Flame Class Rating	0.75	mm	UL 94
UL Recognized, 94HB Flame Class Rating 2nd value	3	mm	UL 94
Glow Wire Flammability Index 850°C, passes at	1	mm	IEC 60695-2-12
Oxygen Index (LOI)	25	%	ISO 4589
INJECTION MOLDING			
Drying Temperature	120	°C	
Drying Time	2 – 4	Hrs	
Maximum Moisture Content	0.02	%	
Melt Temperature	280 – 310	°C	
Nozzle Temperature	270 – 290	°C	
Front - Zone 3 Temperature	280 – 310	°C	
Middle - Zone 2 Temperature	270 – 290	°C	
Rear - Zone 1 Temperature	260 – 280	°C	
Hopper Temperature	60 – 80	°C	
Mold Temperature	80 – 110	°C	

DISCLAIMER

Any sale by SABIC, its subsidiaries and affiliates (each a "seller"), is made exclusively under seller's standard conditions of sale (available upon request) unless agreed otherwise in writing and signed on behalf of the seller. While the information contained herein is given in good faith, SELLER MAKES NO WARRANTY, EXPRESS OR IMPLIED, INCLUDING MERCHANTABILITY AND NONINFRINGEMENT OF INTELLECTUAL PROPERTY, NOR ASSUMES ANY LIABILITY, DIRECT OR INDIRECT, WITH RESPECT TO THE PERFORMANCE, SUITABILITY OR FITNESS FOR INTENDED USE OR PURPOSE OF THESE PRODUCTS IN ANY APPLICATION. Each customer must determine the suitability of seller materials for the customer's particular use through appropriate testing and analysis. No statement by seller concerning a possible use of any product, service or design is intended, or should be construed, to grant any license under any patent or other intellectual property right.